

Chips



Granuli in resina ureica *Urea resin chips*

Granuli in resina ureica per la finitura di particolari in zama.

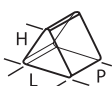
Urea resin chips for zink alloy finishing.

Cono
Cone



	L	H
	25	25
	30	30
	35	35
	40	40
	60	60

Triángolo
Triangle



	L	H	P
	15	15	15
	20	20	20

Paraboloide
Paraboloid



	L	H	P
	70	70	40
	50	50	30

Tetraedro
Tetrahedron



	L	H
	20	20
	30	30



Materiale asciugante *Drying material*

Tutolo di mais per asciugatura e speciali applicazioni.

Drying material extracted from maize-cob and employed for drying processes.

Materiale asciugante
Drying Material

06	3000/4500 µm
08	2000/3000 µm
12	1500/2000 µm
16	1050/1500 µm
20	750/1050 µm
30	450/750 µm
40	180/450 µm